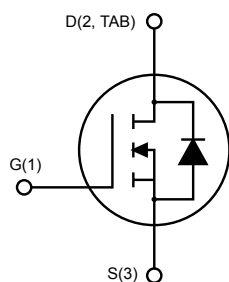
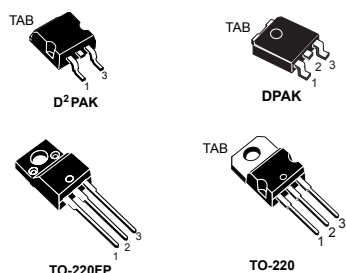


## N-channel 200 V, 0.11 $\Omega$ , 15 A, MESH OVERLAY™ Power MOSFETs in D<sup>2</sup>PAK, DPAK, TO-220FP and TO-220 packages



AM01475v1\_noZen

### Features

| Type      | V <sub>DS</sub> | R <sub>DS(on)</sub> max. | I <sub>D</sub> | Package            |
|-----------|-----------------|--------------------------|----------------|--------------------|
| STB19NF20 | 200 V           | 0.16 $\Omega$            | 15 A           | D <sup>2</sup> PAK |
| STD19NF20 |                 |                          |                | DPAK               |
| STF19NF20 |                 |                          |                | TO-220FP           |
| STP19NF20 |                 |                          |                | TO-220             |

- Extremely high dv/dt capability
- Gate charge minimized
- Very low intrinsic capacitance

### Applications

- Switching applications

### Description

These Power MOSFETs are designed using STMicroelectronics' consolidated strip-layout-based MESH OVERLAY™ process. The result is a product that matches or improves on the performance of comparable standard parts from other manufacturers.

#### Product status links

[STB19NF20](#)  
[STD19NF20](#)  
[STF19NF20](#)  
[STP19NF20](#)

## 1 Electrical ratings

**Table 1. Absolute maximum ratings**

| Symbol                         | Parameter                                                                                                       | Value                            |                     | Unit |
|--------------------------------|-----------------------------------------------------------------------------------------------------------------|----------------------------------|---------------------|------|
|                                |                                                                                                                 | D <sup>2</sup> PAK, DPAK, TO-220 | TO-220FP            |      |
| V <sub>DS</sub>                | Drain-source voltage                                                                                            | 200                              |                     |      |
| V <sub>GS</sub>                | Gate-source voltage                                                                                             | ±20                              |                     | V    |
| I <sub>D</sub>                 | Drain current (continuous) at T <sub>C</sub> = 25 °C                                                            | 15                               | 15 <sup>(1)</sup>   | A    |
|                                | Drain current (continuous) at T <sub>C</sub> = 100 °C                                                           | 9.45                             | 9.45 <sup>(1)</sup> |      |
| I <sub>DM</sub> <sup>(2)</sup> | Drain current (pulsed)                                                                                          | 60                               | 60 <sup>(1)</sup>   | A    |
| P <sub>TOT</sub>               | Total dissipation at T <sub>case</sub> = 25 °C                                                                  | 90                               | 25                  | W    |
| V <sub>ISO</sub>               | Insulation withstand voltage (RMS) from all three leads to external heat sink (t = 1 s, T <sub>C</sub> = 25 °C) |                                  | 2.5                 | kV   |
| dv/dt <sup>(3)</sup>           | Peak diode recovery voltage slope                                                                               | 15                               |                     | V/ns |
| T <sub>stg</sub>               | Storage temperature range                                                                                       | -55 to 150                       |                     | °C   |
| T <sub>j</sub>                 | Operating junction temperature range                                                                            |                                  |                     |      |

1. This value is limited by package.
2. Pulse width is limited by safe operating area.
3.  $I_{SD} \leq 15$  A,  $di/dt \leq 300$  A/ $\mu$ s,  $V_{DD} = 80\%$  V<sub>(BR)DSS</sub>

**Table 2. Thermal data**

| Symbol                              | Parameter                           | Value              |      |        |          | Unit |
|-------------------------------------|-------------------------------------|--------------------|------|--------|----------|------|
|                                     |                                     | D <sup>2</sup> PAK | DPAK | TO-220 | TO-220FP |      |
| R <sub>thj-case</sub>               | Thermal resistance junction-case    | 1.39               |      |        | 5        | °C/W |
| R <sub>thj-pcb</sub> <sup>(1)</sup> | Thermal resistance junction-pcb     | 35                 | 50   |        |          |      |
| R <sub>thj-amb</sub>                | Thermal resistance junction-ambient |                    |      | 62.5   |          |      |

1. When mounted on an 1-inch<sup>2</sup> FR-4, 2oz Cu board

**Table 3. Avalanche characteristics**

| Symbol          | Parameter                                                                                                                  | Value | Unit |
|-----------------|----------------------------------------------------------------------------------------------------------------------------|-------|------|
| I <sub>AR</sub> | Avalanche current, repetitive or not repetitive (pulse width limited by T <sub>jmax</sub> )                                | 15    | A    |
| E <sub>AS</sub> | Single-pulse avalanche energy (starting T <sub>j</sub> = 25 °C, I <sub>D</sub> = I <sub>AR</sub> , V <sub>DD</sub> = 50 V) | 110   | mJ   |

## 2 Electrical characteristics

( $T_{case} = 25\text{ }^{\circ}\text{C}$  unless otherwise specified)

**Table 4. Static**

| Symbol        | Parameter                         | Test conditions                                                                                | Min. | Typ. | Max.      | Unit          |
|---------------|-----------------------------------|------------------------------------------------------------------------------------------------|------|------|-----------|---------------|
| $V_{(BR)DSS}$ | Drain-source breakdown voltage    | $V_{GS} = 0\text{ V}$ , $I_D = 1\text{ mA}$                                                    | 200  |      |           | V             |
| $I_{DSS}$     | Zero gate voltage drain current   | $V_{GS} = 0\text{ V}$ , $V_{DS} = 200\text{ V}$                                                |      |      | 1         | $\mu\text{A}$ |
|               |                                   | $V_{GS} = 0\text{ V}$ , $V_{DS} = 200\text{ V}$ ,<br>$T_C = 125\text{ }^{\circ}\text{C}^{(1)}$ |      |      | 10        |               |
| $I_{GSS}$     | Gate-body leakage current         | $V_{DS} = 0\text{ V}$ , $V_{GS} = \pm 20\text{ V}$                                             |      |      | $\pm 100$ | nA            |
| $V_{GS(th)}$  | Gate threshold voltage            | $V_{DS} = V_{GS}$ , $I_D = 250\text{ }\mu\text{A}$                                             | 2    | 3    | 4         | V             |
| $R_{DS(on)}$  | Static drain-source on-resistance | $V_{GS} = 10\text{ V}$ , $I_D = 7.5\text{ A}$                                                  |      | 0.11 | 0.16      | $\Omega$      |

1. Defined by design, not subject to production test.

**Table 5. Dynamic**

| Symbol    | Parameter                    | Test conditions                                                                                                                                 | Min. | Typ. | Max. | Unit |
|-----------|------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------|------|------|------|------|
| $C_{iss}$ | Input capacitance            | $V_{DS} = 25\text{ V}$ , $f = 1\text{ MHz}$ , $V_{GS} = 0\text{ V}$                                                                             | -    | 800  | -    | pF   |
| $C_{oss}$ | Output capacitance           |                                                                                                                                                 | -    | 165  | -    |      |
| $C_{rss}$ | Reverse transfer capacitance |                                                                                                                                                 | -    | 26   | -    |      |
| $Q_g$     | Total gate charge            | $V_{DD} = 160\text{ V}$ , $I_D = 15\text{ A}$ ,<br>$V_{GS} = 0\text{ to }10\text{ V}$<br>(see Figure 16. Test circuit for gate charge behavior) | -    | 24   | -    | nC   |
| $Q_{gs}$  | Gate-source charge           |                                                                                                                                                 | -    | 4.4  | -    |      |
| $Q_{gd}$  | Gate-drain charge            |                                                                                                                                                 | -    | 11.6 | -    |      |

**Table 6. Switching times**

| Symbol       | Parameter           | Test conditions                                                                                         | Min. | Typ. | Max. | Unit |
|--------------|---------------------|---------------------------------------------------------------------------------------------------------|------|------|------|------|
| $t_{d(on)}$  | Turn-on delay time  | $V_{DD} = 100\text{ V}$ , $I_D = 7.5\text{ A}$ ,<br>$R_G = 4.7\text{ }\Omega$ , $V_{GS} = 10\text{ V}$  | -    | 11.5 | -    | ns   |
| $t_r$        | Rise time           |                                                                                                         | -    | 22   | -    |      |
| $t_{d(off)}$ | Turn-off delay time | (see Figure 15. Test circuit for resistive load switching times and Figure 20. Switching time waveform) | -    | 19   | -    |      |
| $t_f$        | Fall time           |                                                                                                         | -    | 11   | -    |      |

**Table 7. Source-drain diode**

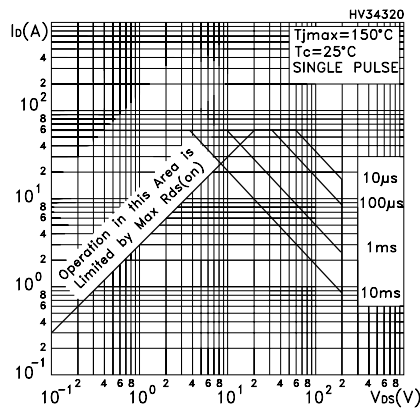
| Symbol          | Parameter                     | Test conditions                                | Min. | Typ. | Max. | Unit |
|-----------------|-------------------------------|------------------------------------------------|------|------|------|------|
| $I_{SD}$        | Source-drain current          |                                                | -    |      | 15   | A    |
| $I_{SDM}^{(1)}$ | Source-drain current (pulsed) |                                                | -    |      | 60   | A    |
| $V_{SD}^{(2)}$  | Forward on voltage            | $I_{SD} = 15\text{ A}$ , $V_{GS} = 0\text{ V}$ | -    |      | 1.6  | V    |

| Symbol    | Parameter                | Test conditions                                                                                                                                                                                                      | Min. | Typ. | Max. | Unit          |
|-----------|--------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|------|------|---------------|
| $t_{rr}$  | Reverse recovery time    | $I_{SD} = 15\text{ A}$ , $di/dt = 100\text{ A}/\mu\text{s}$ ,<br>$V_{DD} = 50\text{ V}$<br>(see Figure 17. Test circuit for inductive load switching and diode recovery times)                                       | -    | 125  |      | ns            |
| $Q_{rr}$  | Reverse recovery charge  |                                                                                                                                                                                                                      | -    | 0.55 |      | $\mu\text{C}$ |
| $I_{RRM}$ | Reverse recovery current |                                                                                                                                                                                                                      | -    | 8.8  |      | A             |
| $t_{rr}$  | Reverse recovery time    | $I_{SD} = 15\text{ A}$ , $di/dt = 100\text{ A}/\mu\text{s}$ ,<br>$V_{DD} = 50\text{ V}$ , $T_j = 150\text{ }^{\circ}\text{C}$<br>(see Figure 17. Test circuit for inductive load switching and diode recovery times) | -    | 148  |      | ns            |
| $Q_{rr}$  | Reverse recovery charge  |                                                                                                                                                                                                                      | -    | 0.73 |      | $\mu\text{C}$ |
| $I_{RRM}$ | Reverse recovery current |                                                                                                                                                                                                                      | -    | 9.9  |      | A             |

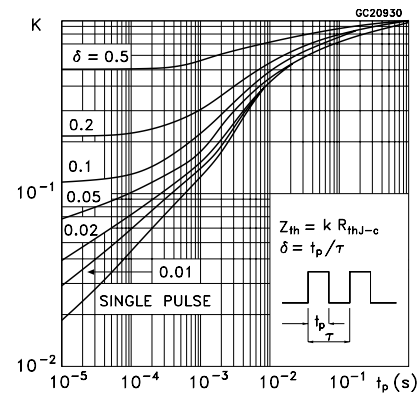
1. Pulse width is limited by safe operating area.
2. Pulse test: pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5%.

## 2.1 Electrical characteristics (curves)

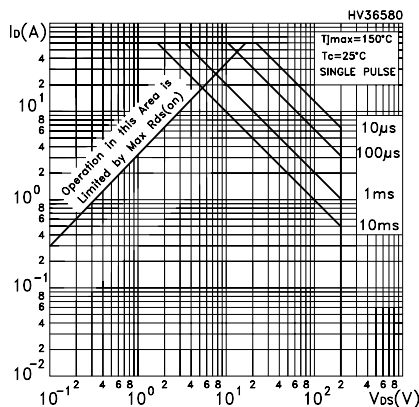
**Figure 1. Safe operating area for D<sup>2</sup>PAK, DPAK and TO-220**



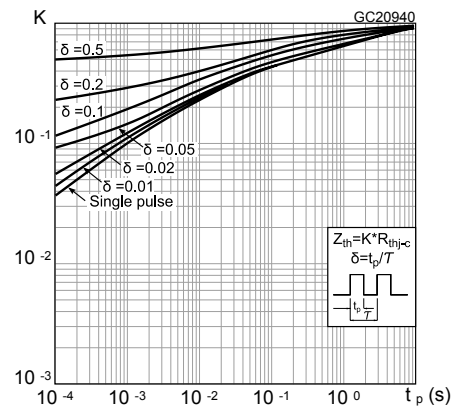
**Figure 2. Thermal impedance for D<sup>2</sup>PAK, DPAK and TO-220**



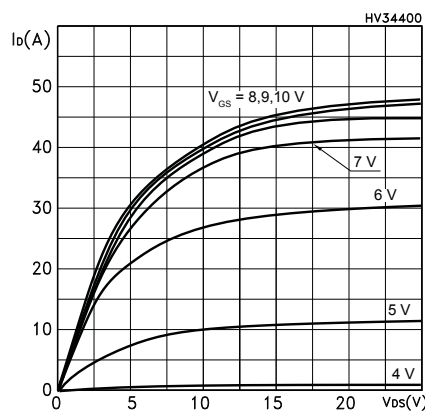
**Figure 3. Safe operating area for TO-220FP**



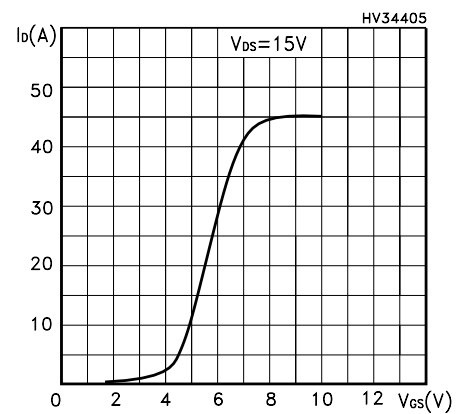
**Figure 4. Thermal impedance for TO-220FP**

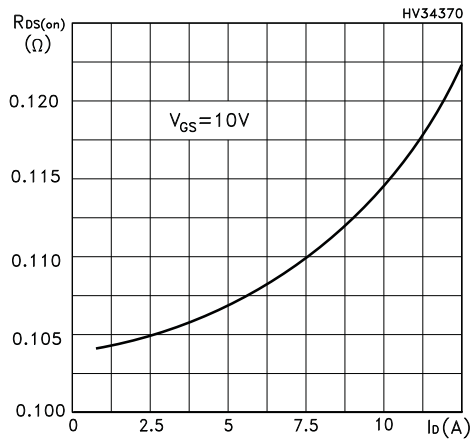
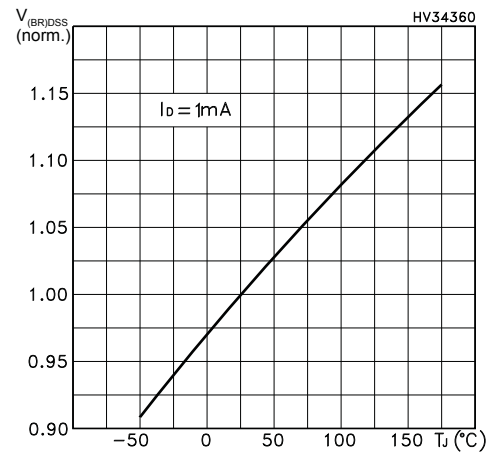
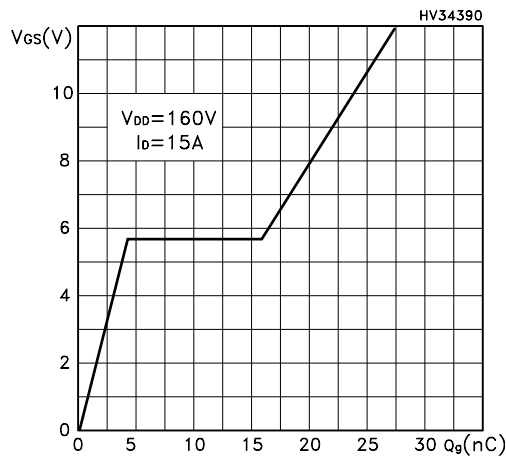
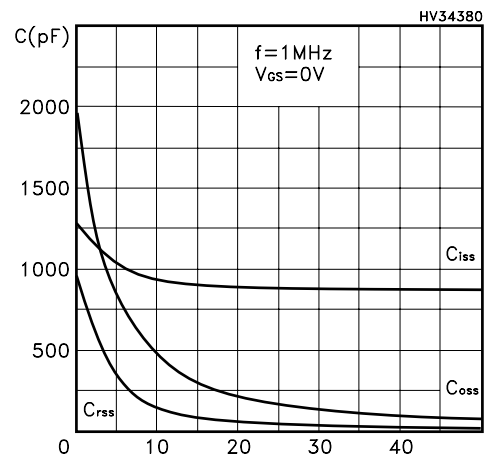
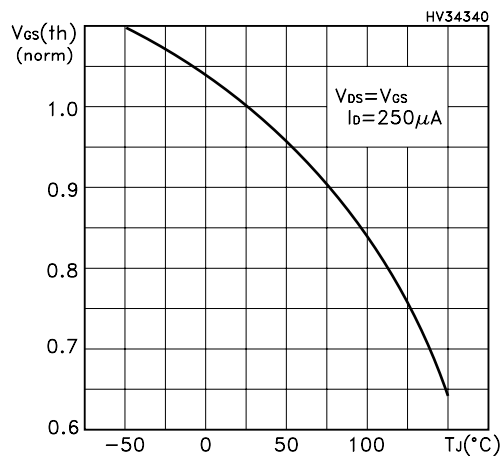
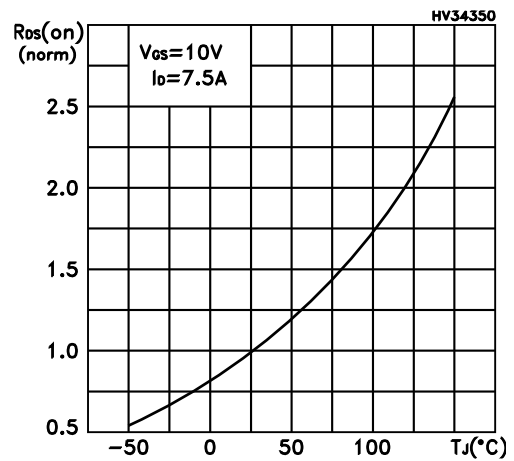


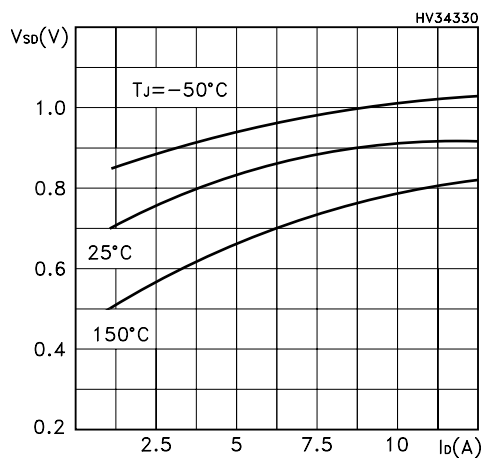
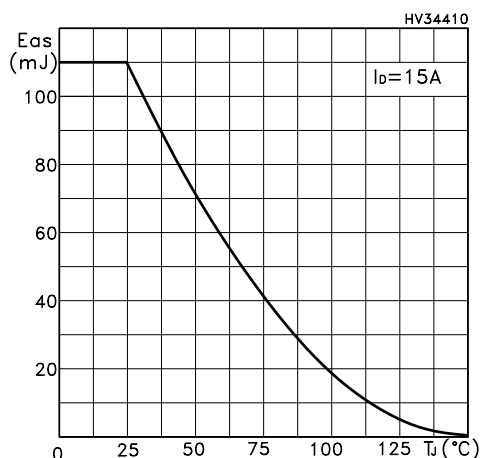
**Figure 5. Output characteristics**



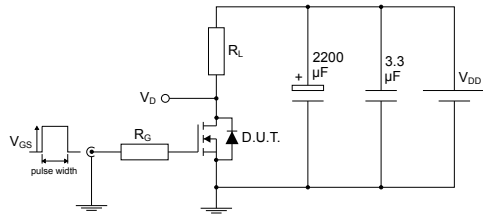
**Figure 6. Transfer characteristics**



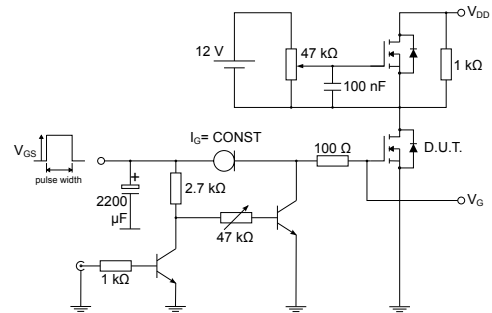
**Figure 7. Static drain-source on-resistance**

**Figure 8. Normalized  $V_{(BR)DSS}$  vs temperature**

**Figure 9. Gate charge vs gate-source voltage**

**Figure 10. Capacitance variations**

**Figure 11. Normalized gate threshold voltage vs temperature**

**Figure 12. Normalized on-resistance vs temperature**


**Figure 13. Source-drain diode forward characteristics**

**Figure 14. Maximum avalanche energy vs temperature**


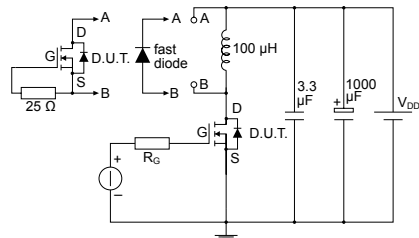
### 3 Test circuits

**Figure 15. Test circuit for resistive load switching times**


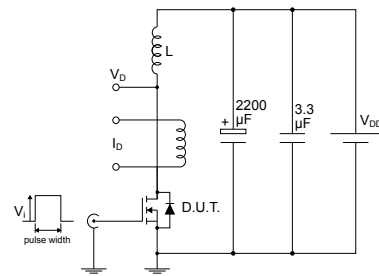
AM01468v1

**Figure 16. Test circuit for gate charge behavior**


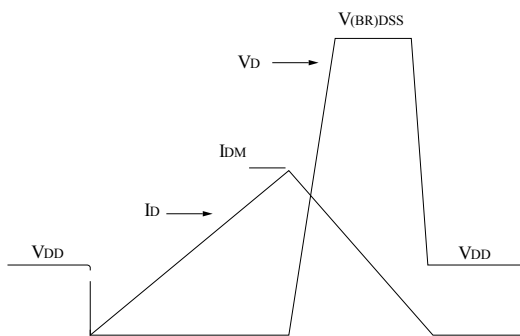
AM01469v1

**Figure 17. Test circuit for inductive load switching and diode recovery times**


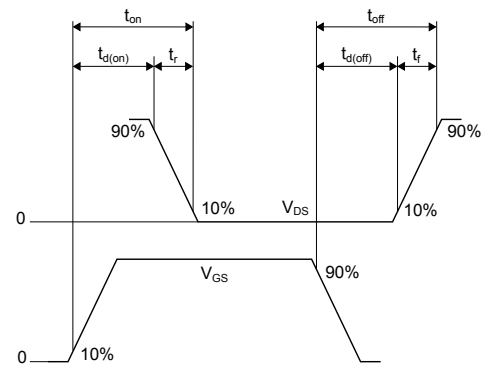
AM01470v1

**Figure 18. Unclamped inductive load test circuit**


AM01471v1

**Figure 19. Unclamped inductive waveform**


AM01472v1

**Figure 20. Switching time waveform**


AM01473v1

## 4 Ordering information

**Table 8. Order codes**

| Order code | Marking | Package            | Packing       |
|------------|---------|--------------------|---------------|
| STB19NF20  | 19NF20  | D <sup>2</sup> PAK | Tape and reel |
| STD19NF20  |         | DPAK               |               |
| STF19NF20  |         | TO-220FP           | Tube          |
| STP19NF20  |         | TO-220             |               |

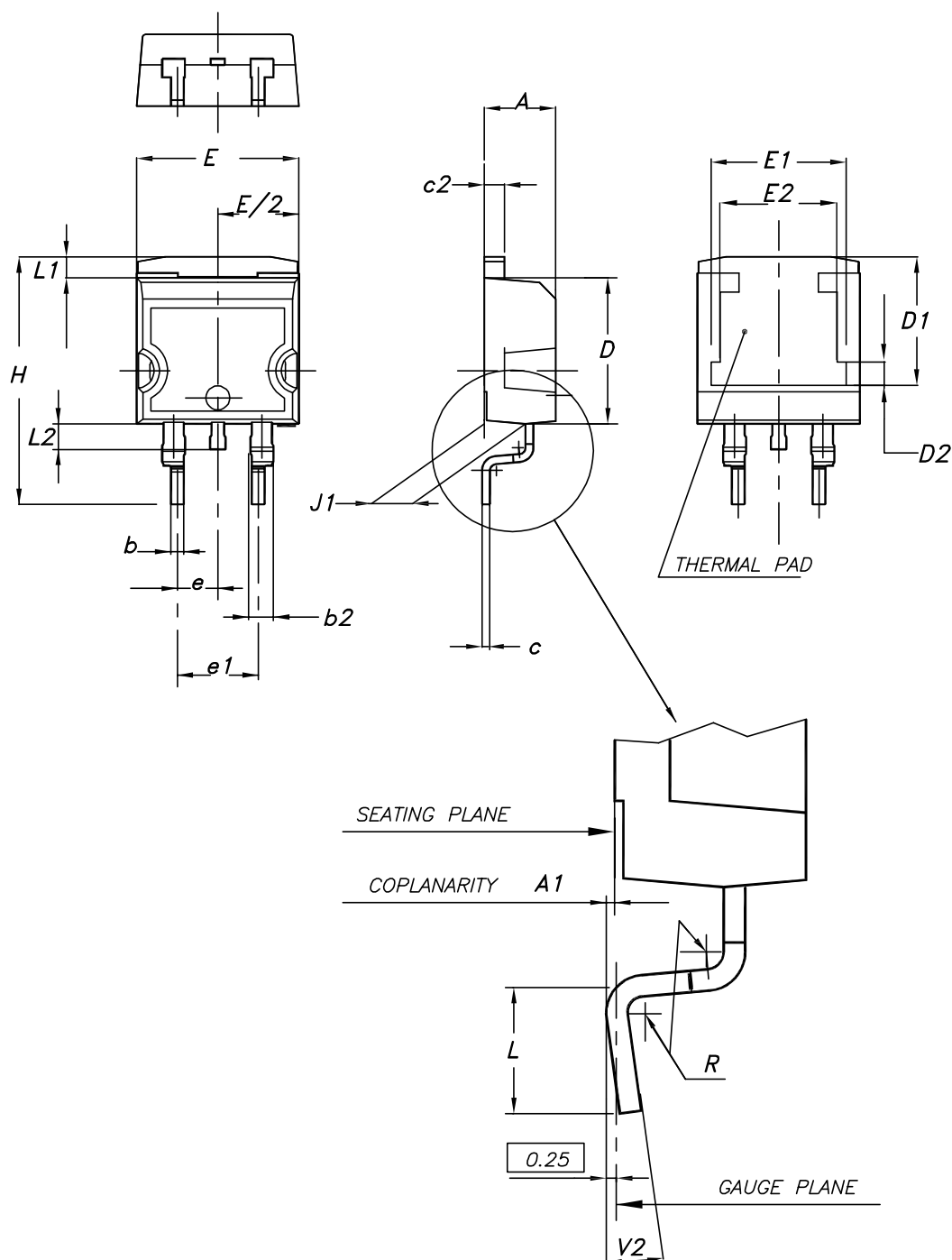
## 5 Package information

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In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK® is an ST trademark.

## 5.1 D<sup>2</sup>PAK (TO-263) type A package information

Figure 21. D<sup>2</sup>PAK (TO-263) type A package outline



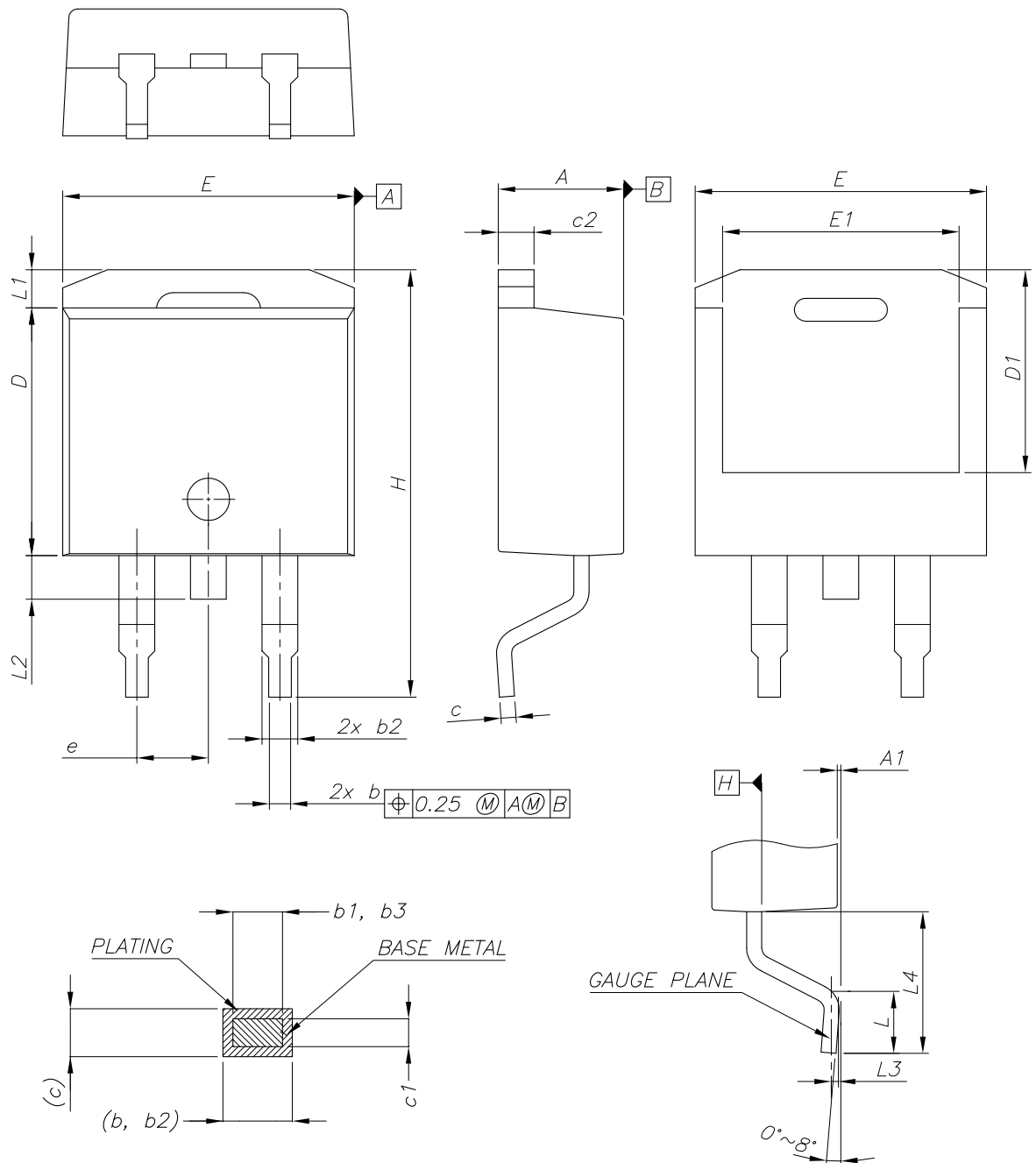
0079457\_25

**Table 9. D<sup>2</sup>PAK (TO-263) type A package mechanical data**

| Dim. | mm    |      |       |
|------|-------|------|-------|
|      | Min.  | Typ. | Max.  |
| A    | 4.40  |      | 4.60  |
| A1   | 0.03  |      | 0.23  |
| b    | 0.70  |      | 0.93  |
| b2   | 1.14  |      | 1.70  |
| c    | 0.45  |      | 0.60  |
| c2   | 1.23  |      | 1.36  |
| D    | 8.95  |      | 9.35  |
| D1   | 7.50  | 7.75 | 8.00  |
| D2   | 1.10  | 1.30 | 1.50  |
| E    | 10.00 |      | 10.40 |
| E1   | 8.30  | 8.50 | 8.70  |
| E2   | 6.85  | 7.05 | 7.25  |
| e    |       | 2.54 |       |
| e1   | 4.88  |      | 5.28  |
| H    | 15.00 |      | 15.85 |
| J1   | 2.49  |      | 2.69  |
| L    | 2.29  |      | 2.79  |
| L1   | 1.27  |      | 1.40  |
| L2   | 1.30  |      | 1.75  |
| R    |       | 0.40 |       |
| V2   | 0°    |      | 8°    |

## 5.2 D<sup>2</sup>PAK (TO-263) type B package information

Figure 22. D<sup>2</sup>PAK (TO-263) type B package outline

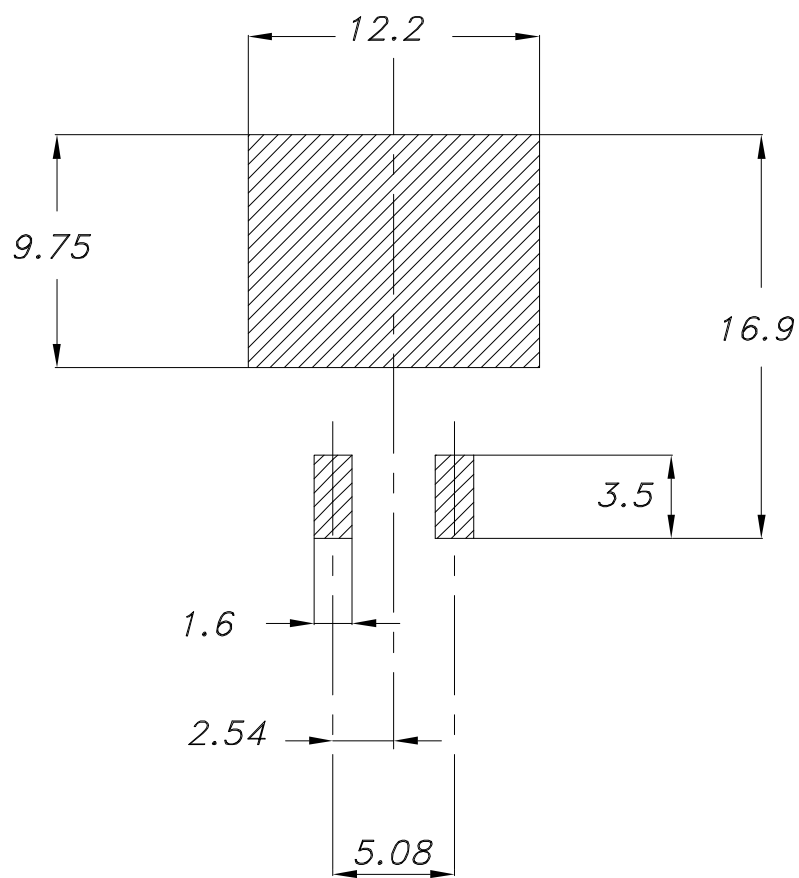


0079457\_25\_B

**Table 10. D<sup>2</sup>PAK (TO-263) type B mechanical data**

| Dim. | mm       |      |       |
|------|----------|------|-------|
|      | Min.     | Typ. | Max.  |
| A    | 4.36     |      | 4.56  |
| A1   | 0        |      | 0.25  |
| b    | 0.70     |      | 0.90  |
| b1   | 0.51     |      | 0.89  |
| b2   | 1.17     |      | 1.37  |
| b3   | 1.36     |      | 1.46  |
| c    | 0.38     |      | 0.694 |
| c1   | 0.38     |      | 0.534 |
| c2   | 1.19     |      | 1.34  |
| D    | 8.60     |      | 9.00  |
| D1   | 6.90     |      | 7.50  |
| E    | 10.15    |      | 10.55 |
| E1   | 8.10     |      | 8.70  |
| e    | 2.54 BSC |      |       |
| H    | 15.00    |      | 15.60 |
| L    | 1.90     |      | 2.50  |
| L1   |          |      | 1.65  |
| L2   |          |      | 1.78  |
| L3   |          | 0.25 |       |
| L4   | 4.78     |      | 5.28  |

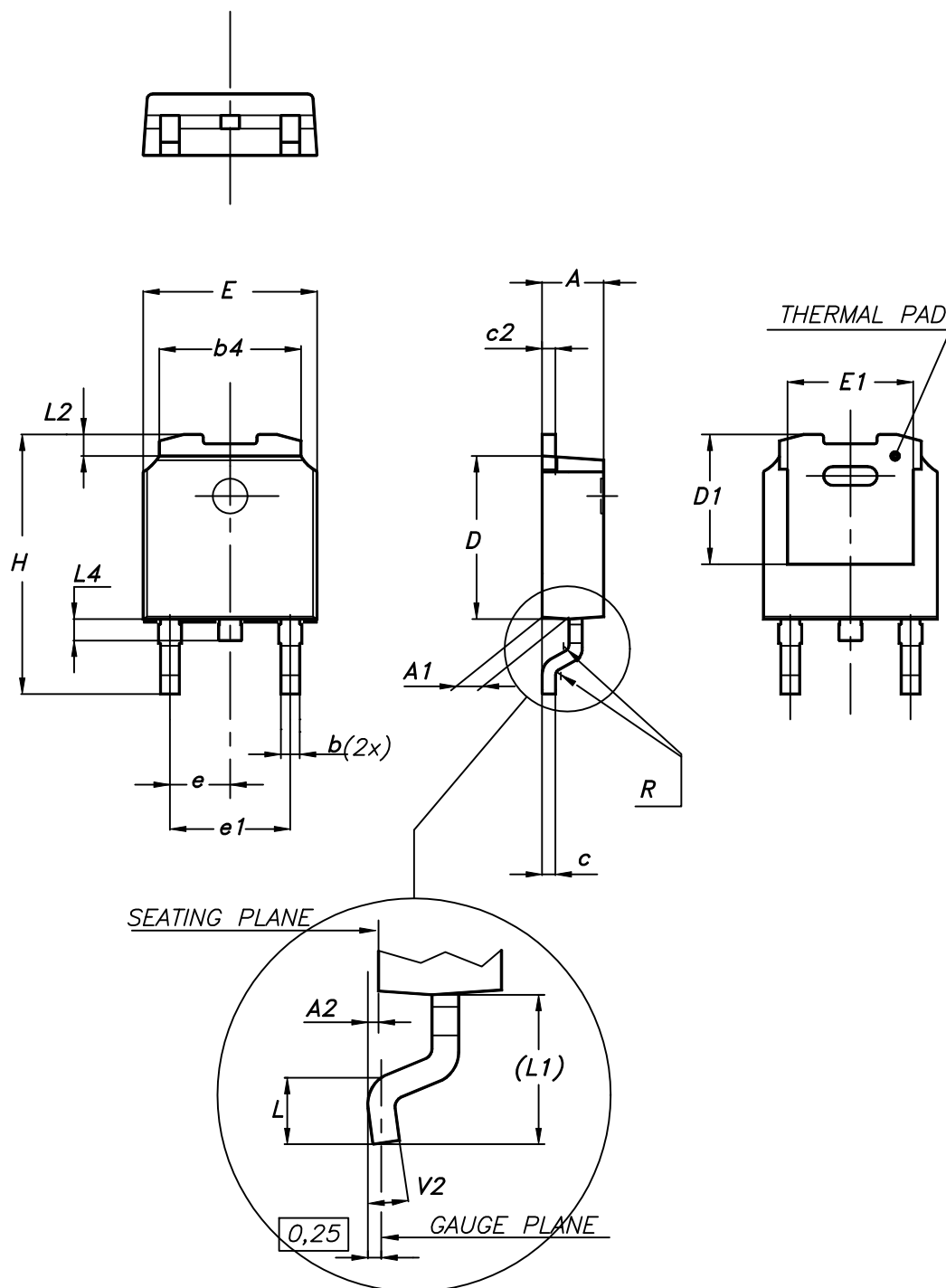
**Figure 23. D<sup>2</sup>PAK (TO-263) recommended footprint (dimensions are in mm)**



Footprint

### 5.3 DPAK (TO-252) type A2 package information

Figure 24. DPAK (TO-252) type A2 package outline



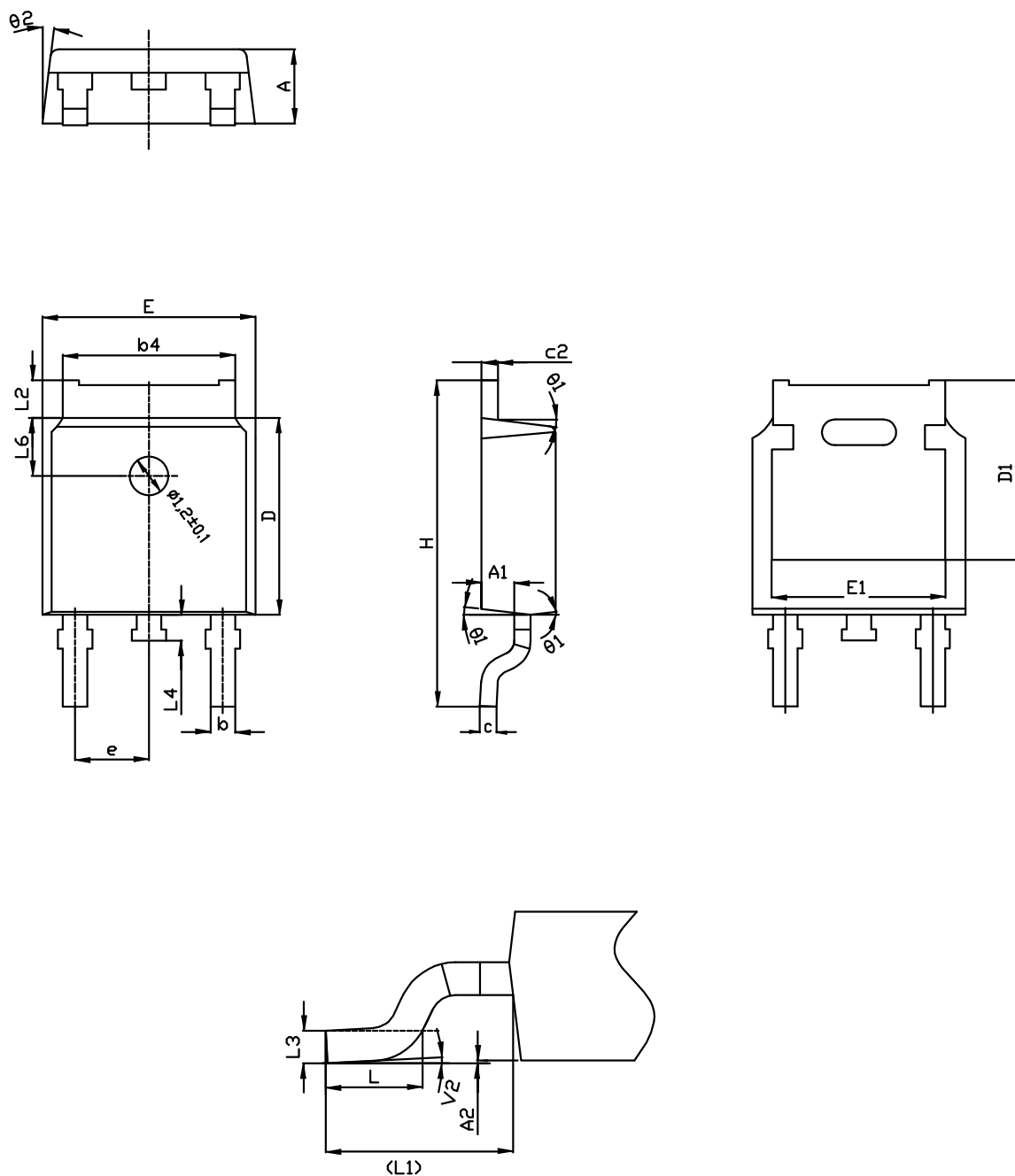
0068772\_type-A2\_rev25

**Table 11. DPAK (TO-252) type A2 mechanical data**

| Dim. | mm    |       |       |
|------|-------|-------|-------|
|      | Min.  | Typ.  | Max.  |
| A    | 2.20  |       | 2.40  |
| A1   | 0.90  |       | 1.10  |
| A2   | 0.03  |       | 0.23  |
| b    | 0.64  |       | 0.90  |
| b4   | 5.20  |       | 5.40  |
| c    | 0.45  |       | 0.60  |
| c2   | 0.48  |       | 0.60  |
| D    | 6.00  |       | 6.20  |
| D1   | 4.95  | 5.10  | 5.25  |
| E    | 6.40  |       | 6.60  |
| E1   | 5.10  | 5.20  | 5.30  |
| e    | 2.159 | 2.286 | 2.413 |
| e1   | 4.445 | 4.572 | 4.699 |
| H    | 9.35  |       | 10.10 |
| L    | 1.00  |       | 1.50  |
| L1   | 2.60  | 2.80  | 3.00  |
| L2   | 0.65  | 0.80  | 0.95  |
| L4   | 0.60  |       | 1.00  |
| R    |       | 0.20  |       |
| V2   | 0°    |       | 8°    |

## 5.4 DPAK (TO-252) type C2 package information

Figure 25. DPAK (TO-252) type C2 package outline

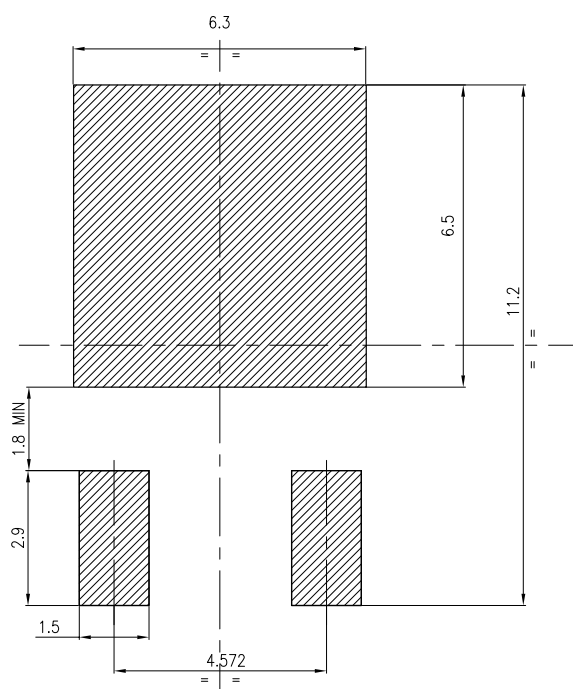


0068772\_C2\_25

**Table 12. DPAK (TO-252) type C2 mechanical data**

| Dim. | mm       |       |       |
|------|----------|-------|-------|
|      | Min.     | Typ.  | Max.  |
| A    | 2.20     | 2.30  | 2.38  |
| A1   | 0.90     | 1.01  | 1.10  |
| A2   | 0.00     |       | 0.10  |
| b    | 0.72     |       | 0.85  |
| b4   | 5.13     | 5.33  | 5.46  |
| c    | 0.47     |       | 0.60  |
| c2   | 0.47     |       | 0.60  |
| D    | 6.00     | 6.10  | 6.20  |
| D1   | 5.10     |       | 5.60  |
| E    | 6.50     | 6.60  | 6.70  |
| E1   | 5.20     |       | 5.50  |
| e    | 2.186    | 2.286 | 2.386 |
| H    | 9.80     | 10.10 | 10.40 |
| L    | 1.40     | 1.50  | 1.70  |
| L1   | 2.90 REF |       |       |
| L2   | 0.90     |       | 1.25  |
| L3   | 0.51 BSC |       |       |
| L4   | 0.60     | 0.80  | 1.00  |
| L6   | 1.80 BSC |       |       |
| θ1   | 5°       | 7°    | 9°    |
| θ2   | 5°       | 7°    | 9°    |
| V2   | 0°       |       | 8°    |

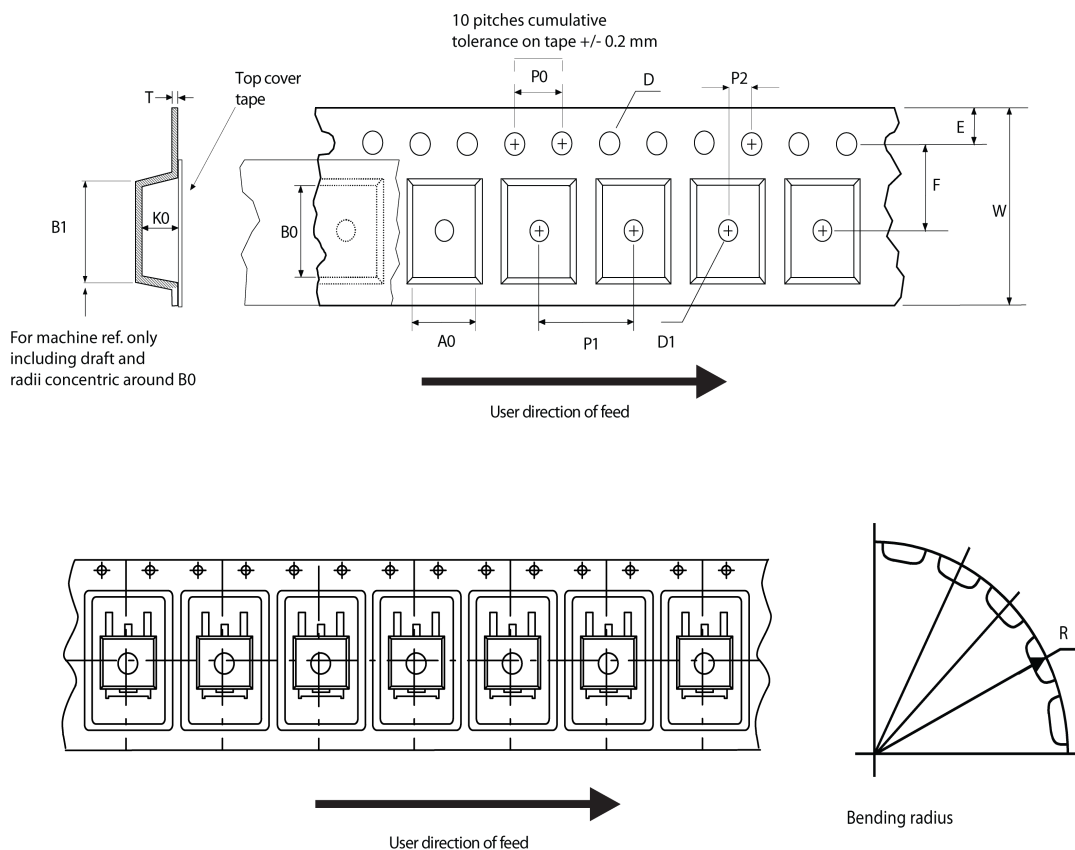
**Figure 26. DPAK (TO-252) recommended footprint (dimensions are in mm)**



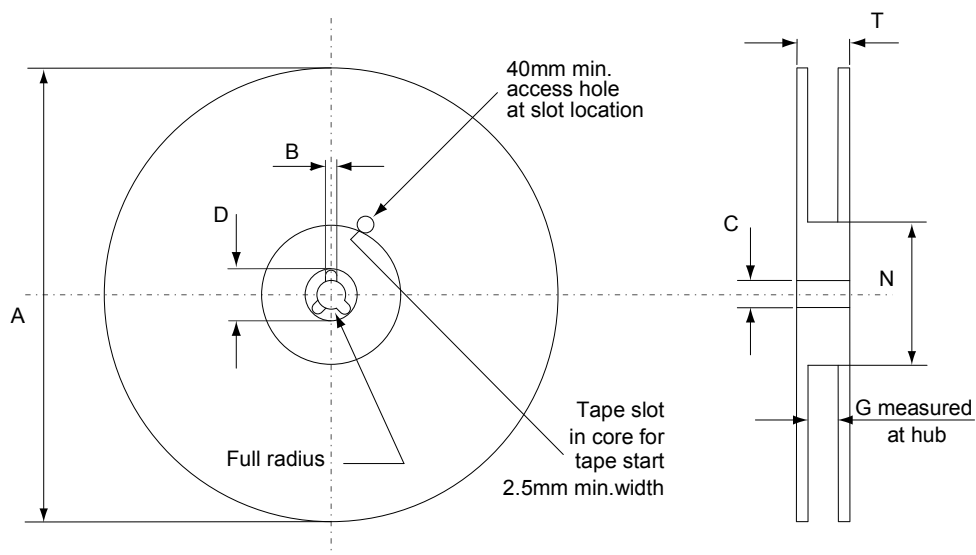
FP\_0068772\_25

## 5.5 D<sup>2</sup>PAK and DPAK packing information

**Figure 27. Tape outline**



AM08852v1

**Figure 28. Reel outline**


AM06038v1

**Table 13. D<sup>2</sup>PAK tape and reel mechanical data**

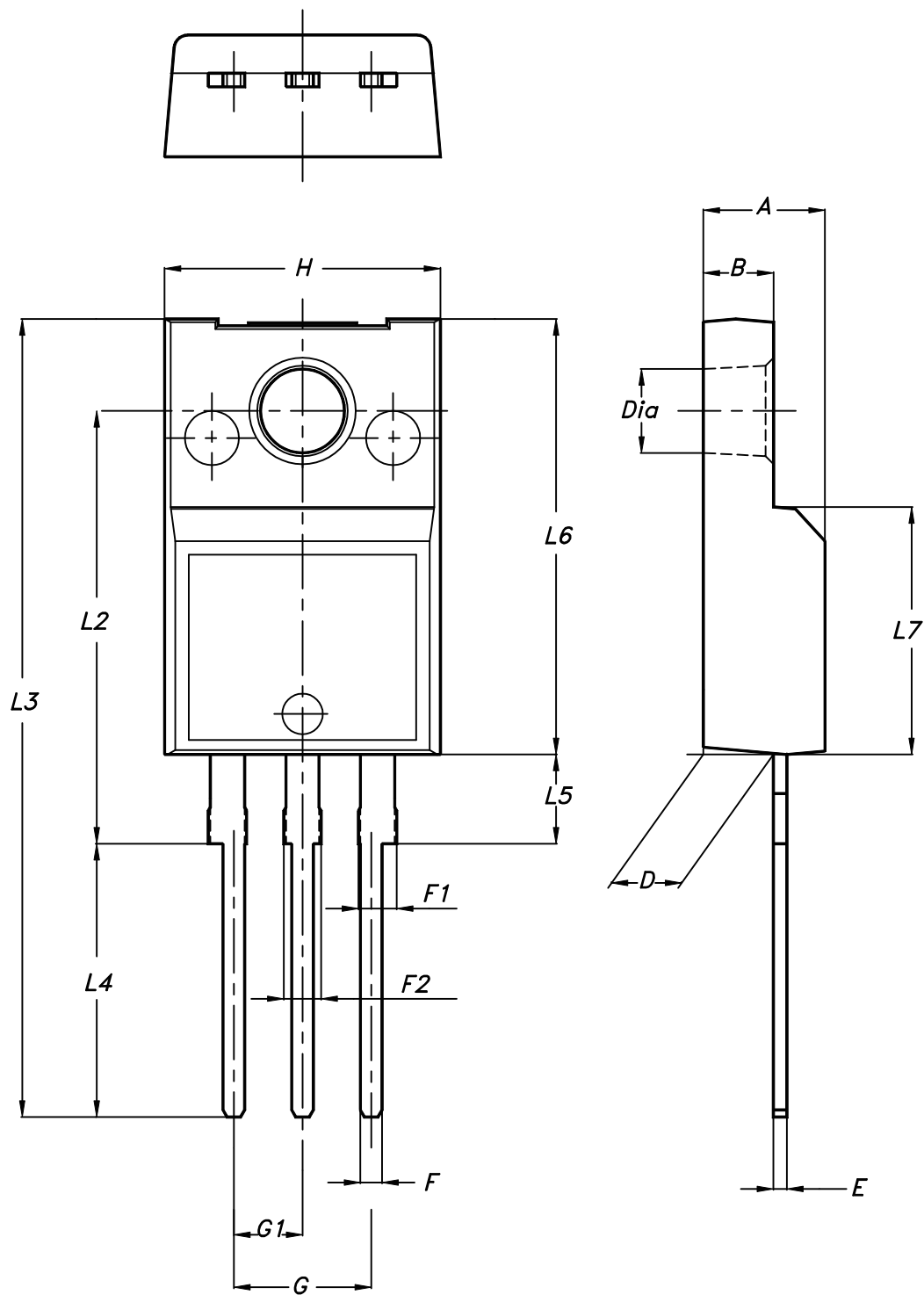
| Tape |      |      | Reel          |      |      |
|------|------|------|---------------|------|------|
| Dim. | mm   |      | Dim.          | mm   |      |
|      | Min. | Max. |               | Min. | Max. |
| A0   | 10.5 | 10.7 | A             |      | 330  |
| B0   | 15.7 | 15.9 | B             | 1.5  |      |
| D    | 1.5  | 1.6  | C             | 12.8 | 13.2 |
| D1   | 1.59 | 1.61 | D             | 20.2 |      |
| E    | 1.65 | 1.85 | G             | 24.4 | 26.4 |
| F    | 11.4 | 11.6 | N             | 100  |      |
| K0   | 4.8  | 5.0  | T             |      | 30.4 |
| P0   | 3.9  | 4.1  |               |      |      |
| P1   | 11.9 | 12.1 | Base quantity |      | 1000 |
| P2   | 1.9  | 2.1  | Bulk quantity |      | 1000 |
| R    | 50   |      |               |      |      |
| T    | 0.25 | 0.35 |               |      |      |
| W    | 23.7 | 24.3 |               |      |      |

**Table 14. DPAK tape and reel mechanical data**

| Tape |      |      | Reel      |      |      |
|------|------|------|-----------|------|------|
| Dim. | mm   |      | Dim.      | mm   |      |
|      | Min. | Max. |           | Min. | Max. |
| A0   | 6.8  | 7    | A         |      | 330  |
| B0   | 10.4 | 10.6 | B         | 1.5  |      |
| B1   |      | 12.1 | C         | 12.8 | 13.2 |
| D    | 1.5  | 1.6  | D         | 20.2 |      |
| D1   | 1.5  |      | G         | 16.4 | 18.4 |
| E    | 1.65 | 1.85 | N         | 50   |      |
| F    | 7.4  | 7.6  | T         |      | 22.4 |
| K0   | 2.55 | 2.75 |           |      |      |
| P0   | 3.9  | 4.1  | Base qty. |      | 2500 |
| P1   | 7.9  | 8.1  | Bulk qty. |      | 2500 |
| P2   | 1.9  | 2.1  |           |      |      |
| R    | 40   |      |           |      |      |
| T    | 0.25 | 0.35 |           |      |      |
| W    | 15.7 | 16.3 |           |      |      |

## 5.6 TO-220FP package information

Figure 29. TO-220FP package outline



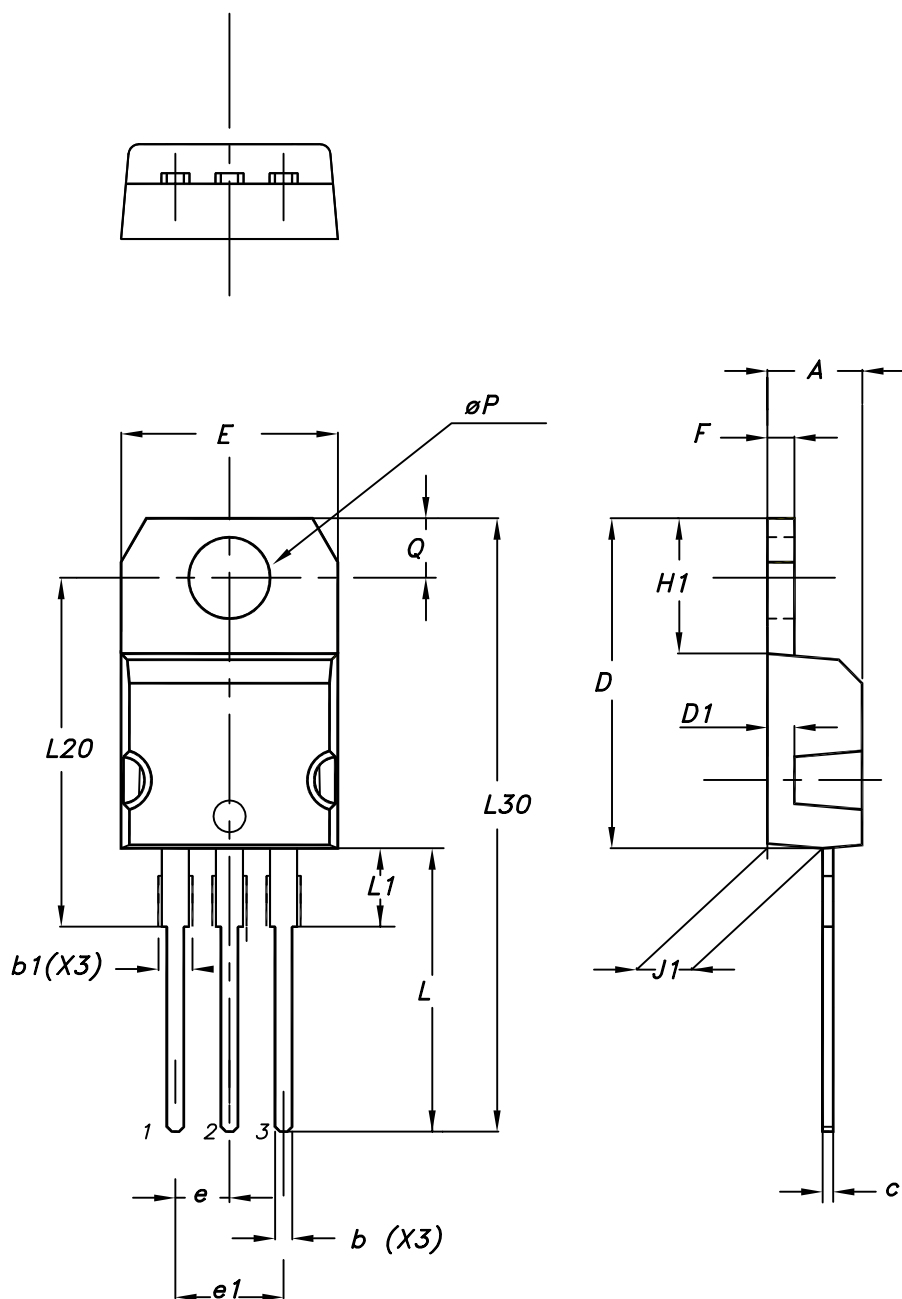
7012510\_Rev\_12\_B

**Table 15. TO-220FP package mechanical data**

| Dim. | mm   |      |      |
|------|------|------|------|
|      | Min. | Typ. | Max. |
| A    | 4.4  |      | 4.6  |
| B    | 2.5  |      | 2.7  |
| D    | 2.5  |      | 2.75 |
| E    | 0.45 |      | 0.7  |
| F    | 0.75 |      | 1    |
| F1   | 1.15 |      | 1.70 |
| F2   | 1.15 |      | 1.70 |
| G    | 4.95 |      | 5.2  |
| G1   | 2.4  |      | 2.7  |
| H    | 10   |      | 10.4 |
| L2   |      | 16   |      |
| L3   | 28.6 |      | 30.6 |
| L4   | 9.8  |      | 10.6 |
| L5   | 2.9  |      | 3.6  |
| L6   | 15.9 |      | 16.4 |
| L7   | 9    |      | 9.3  |
| Dia  | 3    |      | 3.2  |

## 5.7 TO-220 type A package information

**Figure 30.** TO-220 type A package outline



0015988\_typeA\_Rev\_21

**Table 16. TO-220 type A package mechanical data**

| Dim. | mm    |       |       |
|------|-------|-------|-------|
|      | Min.  | Typ.  | Max.  |
| A    | 4.40  |       | 4.60  |
| b    | 0.61  |       | 0.88  |
| b1   | 1.14  |       | 1.55  |
| c    | 0.48  |       | 0.70  |
| D    | 15.25 |       | 15.75 |
| D1   |       | 1.27  |       |
| E    | 10.00 |       | 10.40 |
| e    | 2.40  |       | 2.70  |
| e1   | 4.95  |       | 5.15  |
| F    | 1.23  |       | 1.32  |
| H1   | 6.20  |       | 6.60  |
| J1   | 2.40  |       | 2.72  |
| L    | 13.00 |       | 14.00 |
| L1   | 3.50  |       | 3.93  |
| L20  |       | 16.40 |       |
| L30  |       | 28.90 |       |
| øP   | 3.75  |       | 3.85  |
| Q    | 2.65  |       | 2.95  |

## Revision history

**Table 17. Document revision history**

| Date        | Version | Changes                                                                                                                                                                                                                                                                                                        |
|-------------|---------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 13-Oct-2006 | 1       | First release.                                                                                                                                                                                                                                                                                                 |
| 17-Nov-2006 | 2       | Part number has been modified.                                                                                                                                                                                                                                                                                 |
| 02-Feb-2007 | 3       | Preliminary version.                                                                                                                                                                                                                                                                                           |
| 16-Feb-2007 | 4       | TO-220FP package has been added.                                                                                                                                                                                                                                                                               |
| 15-Oct-2012 | 5       | Updated <i>Section 4: Package information</i> and <i>Section 4: Package information</i> .<br>Minor text changes.                                                                                                                                                                                               |
| 16-Apr-2015 | 6       | Throughout document:<br>– added DPAK package information<br>– text and formatting updates<br>Updated <i>Figure 1: Internal schematic diagram</i><br>Updated <i>Table 2: Absolute maximum ratings</i><br>Updated <i>Table 3: Thermal data</i><br>Updated and renamed <i>Table 5: Static</i> (was On/off states) |
| 09-Aug-2018 | 7       | Removed maturity status indication from cover page. The document status is production data.<br>Updated <a href="#">Table 5. Dynamic</a> .<br>Updated <a href="#">Section 5 Package information</a> .<br>Minor text changes                                                                                     |

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